SD12CT1

ESD Protection Diode

Bi-directional ESD Protection with Ultra Low Clamping Voltage

The SD12C is designed to protect voltage sensitive components from ESD and transient events. Excellent clamping capability, low leakage, and fast response time, make this part ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, portable devices, digital cameras, power supplies and many other portable applications.

Specification Features:

- Peak Power 350 W (8 \times 20 μ s)
- Low Leakage
- Low Clamping Voltage
- Small Package for use in Portable Electronics
- Meets IEC61000-4-2 Level 4
- Meets IEC6100-4-4 Level 4
- Meets 16 kV Human Body Model ESD Requirements
- These Devices are Pb-Free and are RoHS Compliant

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic

Epoxy Meets UL 94, V–0 **MOUNTING POSITION:** Any

QUALIFIED MAX REFLOW TEMPERATURE: 260°C

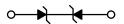
Device Meets MSL 1 Requirements

Replace the "T1" with "T3" in the Device Number to order the 13 inch/10,000 unit reel.



ON Semiconductor®

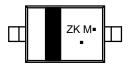
www.onsemi.com





SOD-323 CASE 477 STYLE 1

MARKING DIAGRAM



ZK = Specific Device Code

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)
*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------|----------------------|-----------------------|
| SD12CT1G | SOD-323 (Pb-Free) | 3000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SD12CT1

MAXIMUM RATINGS

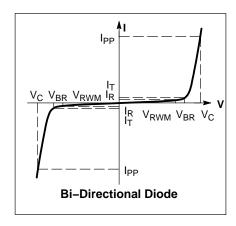
| Rating | | Symbol | Value | Unit |
|---|----------------|-----------------------------------|-------------|-------------|
| Peak Power Dissipation @ 20 μs @ $T_L \le 25^{\circ}C$ | | P_{pk} | 350 | W |
| IEC 61000-4-2 (ESD) | Air Contact | | ±30 ±30 | kV |
| IEC 61000-4-4 (EFT) | | | 40 | А |
| Total Device Dissipation FR–5 Board, (Note 1) @ T _A = 25°C Derate above 25°C | | P _D | 200 1.5 | mW mW/°C |
| Thermal Resistance from Junction-to-Ambient | | $R_{\theta JA}$ | 635 | °C/W |
| Junction and Storage Temperature Range | | T _J , T _{stg} | -65 to +150 | °C |
| Lead Solder Temperature – Maximum (10 Second Duration) | | T_L | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

| Symbol | Parameter |
|-----------------|--|
| I _{PP} | Maximum Reverse Peak Pulse Current |
| V _C | Clamping Voltage @ IPP |
| V_{RWM} | Working Peak Reverse Voltage |
| I _R | Maximum Reverse Leakage Current @ V _{RWM} |
| V_{BR} | Breakdown Voltage @ I _T |
| Ι _Τ | Test Current |
| ΘV_{BR} | Maximum Temperature Variation of V _{BR} |



ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$, unless otherwise specified)

| Parameter | Conditions | Symbol | Min | Тур | Max | Unit |
|---|---|-----------------|------|-----|----------|------|
| Reverse Working Voltage | (Note 2) | V_{RWM} | | | 12 | V |
| Breakdown Voltage | I _T = 1 mA, (Note 3) | V_{BR} | 13.3 | | | V |
| Reverse Leakage Current | V _{RWM} = 12 V | I _R | | | 1.0 | μΑ |
| Clamping Voltage Additional Clamping Voltage | I _{PP} = 5 A, (8 x 20 μsec Waveform) I _{PP} = 15 A, (8 x 20 μsec Waveform) | V _C | | | 19 24 | V |
| Maximum Peak Pulse Current | 8 x 20 μsec Waveform | I _{PP} | | | 15 | Α |
| Capacitance | V _R = 0 V, f = 1 MHz | C _j | | 64 | | pF |
| | V _R = 12 V, f = 1 MHz | 1 | | 36 | | 1 |

 $^{2. \ \ \}text{TVS devices are normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal or greater than the DC}$ or continuous peak operating voltage level.

3. V_{BR} is measured at pulse test current I_T.

^{1.} Minimum Solder Footprint.

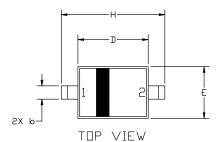






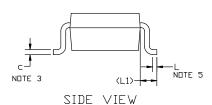
SOD-323 1.70x1.25x0.85 **CASE 477 ISSUE K**

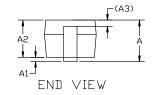
DATE 11 MAR 2024



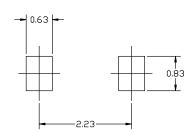
NOTES:

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
- CONTROLLING DIMENSION: MILLIMETERS. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH 3. SOLDER PLATING.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
 DIMENSION L IS MEASURE FROM END OF RADIUS.





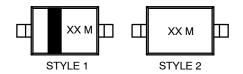
| DIM | MILLIMETERS | | | |
|-------|-------------|------|------|--|
| ואוזת | MIN. | N□M. | MAX. | |
| Α | 0.80 | 0.90 | 1.00 | |
| A1 | 0.00 | 0.05 | 0.10 | |
| A2 | 0.75 | 0.85 | 0.95 | |
| А3 | 0.15 (REF) | | | |
| b | 0.25 | 0.32 | 0.4 | |
| U | 0.09 | 0.12 | 0.18 | |
| D | 1.60 | 1.70 | 1.80 | |
| E | 1.15 | 1.25 | 1.35 | |
| I | 2.30 | 2.50 | 2.70 | |
| Ĺ | 0.08 | | | |
| L1 | 0.40 (REF) | | | |



RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques
Reference manual, SDLDERRM/D.

GENERIC MARKING DIAGRAM*



XX = Specific Device Code M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

STYLE 2: NO POLARITY PIN 1. CATHODE (POLARITY BAND) 2. ANODE

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|------------------|------------------------|---|-------------|--|
| DESCRIPTION: | SOD-323 1.70x1.25x0.85 | | PAGE 1 OF 1 | |

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